

Agilent HSMx-A16x-xxxxx PLCC-2 Surface Mount LED Indicator Black Surface Tinted

Data Sheet

Description

This family of SMT LEDs is packaged in the industry standard PLCC-2 package. These SMT LEDs have high reliability performance and are designed to work under a wide range of environmental conditions. This high reliability feature makes them ideally suited to be used under harsh interior signs application conditions. This SMT LED package come with a black surface and tinted which is specially designed for signs application to minimize ambient reflection to improve contrast.

To facilitate easy pick & place assembly, the LEDs are packed in EIA-compliant tape and reel. Every reel will be shipped in single intensity and color bin, except red color, to provide close uniformity.

These LEDs are compatible with IR solder reflow process. Due to the high reliability feature of these products, they can also be mounted using through-the-wave soldering process.

The super wide viewing angle at 120° makes these LEDs ideally suited for panel, push button, or general backlighting in automotive interior, office equipment, industrial equipment, and home appliances. The flat top emitting surface makes it easy for these LEDs to mate with light pipes. With the built-in reflector pushing up the intensity of the light output, these LEDs are also suitable to be used as LED pixels in interior electronic signs.

Features

- · Industry standard PLCC-2 package
- · High reliability LED package
- High brightness using AlInGaP and InGaN dice technologies
- · Available in full selection of colors
- Super wide viewing angle at 120°
- Available in 8 mm carrier tape on 7 inch reel (2000 pieces)
- Compatible with both IR and TTW soldering process
- · Black Surface Tinted

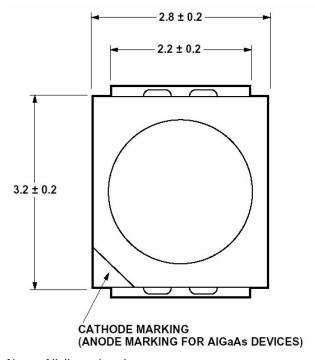
Applications

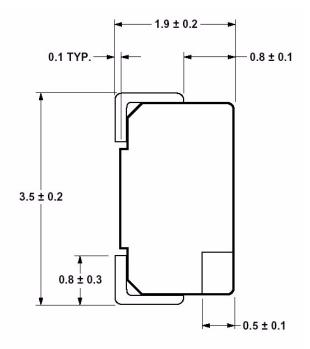
- · Electronic signs and signals
 - Interior full color sign
 - · Variable message sign

CAUTION: HSMM and HSMN-A1xx-xxxxx LEDs are Class 2 ESD sensitive. Please observe appropriate precautions during handling and processing. Refer to Agilent Application Note AN-1142 for additional details.



Package Dimensions





Notes: All dimensions in mm

Device Selection Guide

| Color | Part Number | Min Iv @ 20mA (mcd) | Typical Iv @ 20mA (mcd) |
|---------------|-----------------|------------------------|----------------------------|
| Red | HSMC-A160-Q00J1 | 63.0 | 100.0 |
| | HSMC-A161-S00J1 | 160.0 | 220.0 |
| | HSMZ-A160-T00J1 | 250.0 | 350.0 |
| Yellow /Amber | HSMA-A160-Q00J1 | 63.0 | 100.0 |
| | HSMA-A161-S00J1 | 160.0 | 220.0 |
| | HSMU-A160-R00J1 | 100.0 | 320.0 |
| | HSMU-A160-T00J1 | 250.0 | 320.0 |
| Green | HSMM-A161-R00J1 | 100.0 | 200.0 |
| | HSMM-A160-S00J1 | 160.0 | 350.0 |
| Blue | HSMN-A161-N00J1 | 25.0 | 50.0 |
| | HSMN-A160-P00J1 | 40.0 | 70.0 |

Notes: The luminous intensity I_{ν} is measured at the mechanical axis of the lamp package. The actual peak of the spatial radiation pattern may not be aligned with this axis.

Absolute Maximum Ratings ($T_A = 25^{\circ}C$)

| Parameters | HSMC/A | HSMV/Z | HSMM/N |
|-------------------------------------|------------------------|------------------------|-----------------|
| DC Forward Current ^[1] | 30 mA ^[3,4] | 30 mA ^[3,4] | 30 mA |
| Peak Forward Current ^[2] | 100mA | 100mA | 100mA |
| Power Dissipation | 63mW | 72mW | 114mW |
| Reverse Voltage | 5 | 5 | 5 |
| Junction Temperature | 110°C | 110°C | 110°C |
| Operating Temperature | -55°C to +100°C | -55°C to +100°C | -55°C to +100°C |
| Storage Temperature | -55°C to +100°C | -55°C to +100°C | -55°C to +100°C |

Notes:

- 1. Derate linearly as shown in figure
- 2. Duty factor = 10%, Frequency = 1kHz.
- 3. Drive Current between 10mA and 30mA are recommended for best long term performance
- 4. Operation at current below 5mA is not recommended.

Optical Characteristic ($T_A = 25^{\circ}C$)

| Color | Part Number | Dice Technology | $\begin{array}{l} \text{Peak} \\ \text{Wavelength} \\ \lambda_{\text{PEAK}} \ (\text{nm}) \\ \text{Typ.} \end{array}$ | $\begin{array}{ll} \textbf{Dominant} \\ \textbf{Wavelength} \\ \lambda_{D \ (nm)}^{[1]} \\ \textbf{Typ.} \end{array}$ | Viewing Angle $2\theta_{1/2}^{[2]}$ (Degrees) Typ. | $\begin{array}{c} \text{Luminous} \\ \text{Efficacy} \eta_{\text{v}}^{[3]} \\ \text{(Im/W)} \end{array}$ Typ | $\begin{array}{l} \text{Luminous} \\ \text{Intensity}/\\ \text{Total Flux} \\ \text{I}_{v}(\text{mcd})/\text{F}_{v}(\text{mlm}) \\ \text{Typ.} \end{array}$ |
|-------|-------------|--------------------|---|---|--|--|---|
| Amber | HSMA-A16x | AllnGaP | 592 | 590 | 120 | 480 | 0.45 |
| Amber | HSMU-A160 | AllnGaP | 594 | 592 | 120 | 500 | 0.45 |
| Red | HSMC-A16x | AllnGaP | 635 | 626 | 120 | 150 | 0.45 |
| Red | HSMZ-A160 | AllnGaP | 639 | 630 | 120 | 155 | 0.45 |
| Green | HSMM-A16x | InGaN | 523 | 525 | 120 | 500 | 0.45 |
| Blue | HSMN-A16x | InGaN | 468 | 470 | 120 | 75 | 0.45 |

Notes:

- 1. The dominant wavelength, λ_D , is derived from the CIE Chromaticity Diagram and represents the color of the device.
- 2. $\theta_{1/2}$ is the off-axis angle where the luminous intensity is 1/2 the peak intensity.
- 3. Radiant intensity, I_e in watts/steradian, may be calculated from the equation $I_e = I_v/\eta_v$, where I_v is the luminous intensity in candelas and η_v is the luminous efficacy in lumens/watt.

Electrical Characteristic ($T_A = 25^{\circ}C$)

| Dice Technology | Forward Voltage V _F (Volts) @ I _F = 20mA | | Reverse Voltage V _R @ 100μA | Reverse Voltage V _R @ 10μA | Thermal Resistance $R\theta_{JP}$ (°C/W) |
|-----------------|---|------|---|--|--|
| | Тур | Max | Min | Min | Тур |
| HSMC/A | 1.9 | 2.4 | 5 | - | 280 |
| HSMV/Z | 2.2 | 2.6 | 5 | - | 280 |
| HSMM/N | 3.4 | 4.05 | - | 5 | 280 |

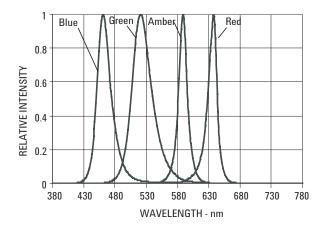


Figure 1. Relative Intensity vs. Wavelength

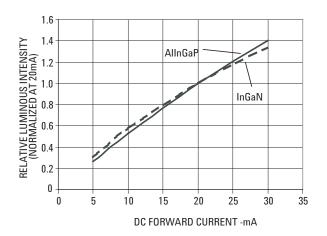


Figure 3. Relative Intensity vs. Forward Current

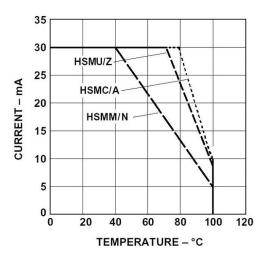


Figure 5. Maximum Forward Current Vs. Ambient Temperature. Derated Based on $\rm\,T_{J}\,MAX=110$ °C, $\rm\,R\theta_{JA}\,500$ °C/W

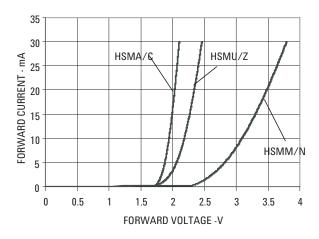


Figure 2. Forward Current vs. Forward Voltage

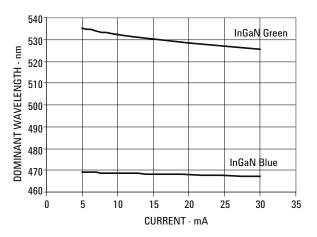


Figure 4. Dominant Wavelength vs. Forward Current – InGaN

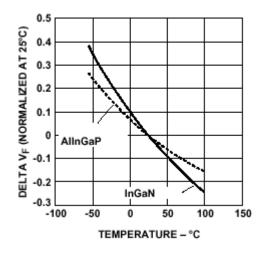


Figure 6. Forward Voltage Shift vs. Temperature

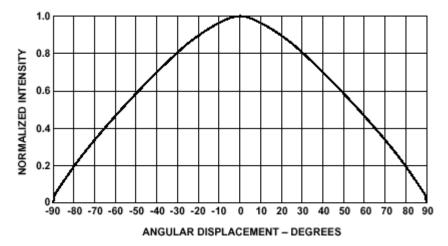


Figure 7. Radiation Pattern

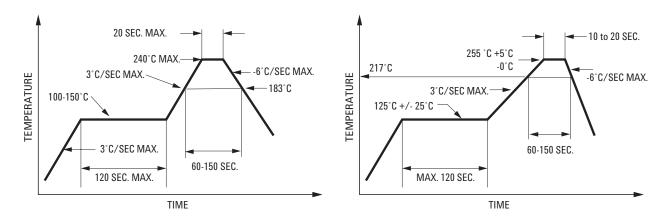


Figure 8a. Recommended SnPb Reflow Soldering Profile

Figure 8b. Recommended Pb-Free Reflow Soldering Profile

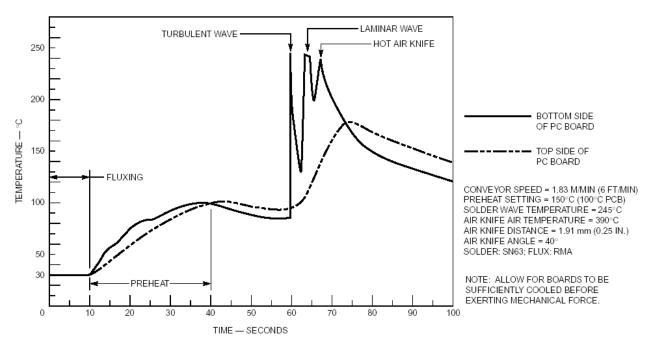
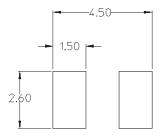
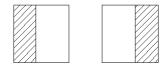


Figure 9. Recommended Wave Soldering Profile





☑ SOLDER RESIST

Figure 10. Recommended soldering pad pattern

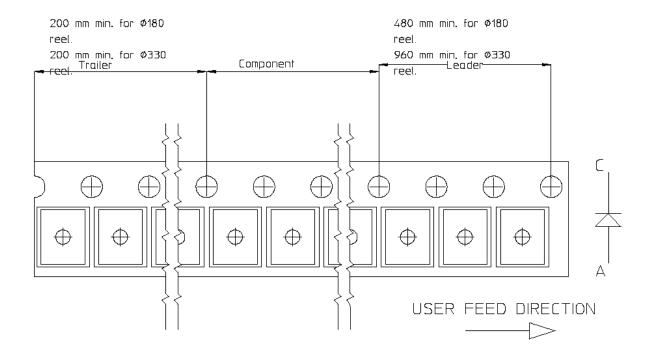


Figure 11. Tape leader and Trailer dimension

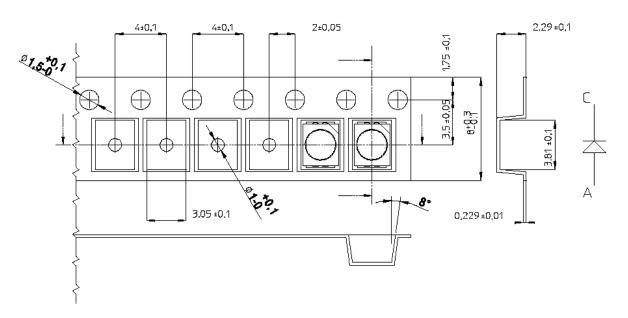


Figure 12. Tape dimension

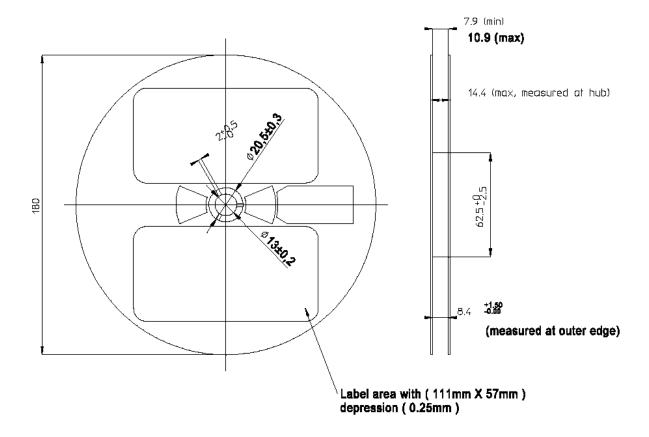


Figure 13. Reel dimension

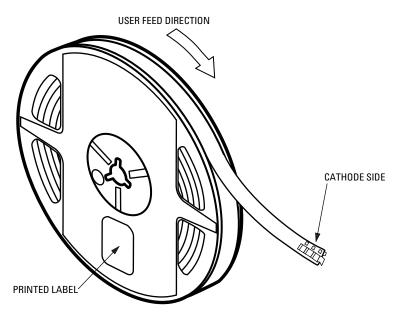


Figure 14. Reeling Orientation

Storage Conditions:

5 to 30° C @ 60% RH max.

Recommended baking conditions:

 $60 + /- 5^{\circ}C$ for 20 hours.

Baking is required under the following conditions:

- a) the humidity indicator card becomes pink in color
- b) the pack has been opened for more than 4 weeks

This product is qualified as Moisture Sensitive JEDEC Level 2A

Intensity Bin Select (X₅X₆)

Individual reel will contain parts from 1 half bin only

| X ₅ | Min Iv Bin |
|----------------|--|
| X ₆ | |
| 0 | Full Distribution |
| 3 | 3 half bins starting from X ₅ 1 |
| 4 | 4 half bins starting from X ₅ 1 |
| 5 | 5 half bins starting from X ₅ 1 |
| 7 | 3 half bins starting from X_52 |
| 8 | 4 half bins starting from X_52 |
| 9 | 5 half bins starting from X ₅ 2 |
| | |

Intensity Bin Limits

| Bin ID | Min (mcd) | Max (mcd) |
|------------|-----------|-----------|
| J1 | 4.50 | 5.60 |
| J2 | 5.60 | 7.20 |
| K1 | 7.20 | 9.00 |
| K2 | 9.00 | 11.20 |
| L1 | 11.20 | 14.00 |
| L2 | 14.00 | 18.00 |
| M1 | 18.00 | 22.40 |
| M2 | 22.40 | 28.50 |
| N1 | 28.50 | 35.50 |
| N2 | 35.50 | 45.00 |
| P1 | 45.00 | 56.00 |
| P2 | 56.00 | 71.50 |
| Q 1 | 71.50 | 90.00 |
| 02 | 90.00 | 112.50 |
| R1 | 112.50 | 140.00 |
| R2 | 140.00 | 180.00 |
| S1 | 180.00 | 224.00 |
| S2 | 224.00 | 285.00 |
| T1 | 285.00 | 355.00 |
| T2 | 355.00 | 450.00 |
| U1 | 450.00 | 560.00 |
| U2 | 560.00 | 715.00 |
| | | |

Tolerance of each bin limit = \pm 12%

Color Bin Select (X₇)

Individual reel will contain parts from 1 full bin only

| X ₇ | |
|----------------|--------------------|
| 0 | Full Distribution |
| Z | A and B only |
| Υ | B and C only |
| W | C and D only |
| V | D and E only |
| U | E and F only |
| T | F and G only |
| S | G and H only |
| Q | A, B and C only |
| Р | B, C and D only |
| N | C, D and E only |
| M | D, E and F only |
| L | E, F and G only |
| K | F, G and H only |
| 1 | A, B, C and D only |
| 2 | E, F G and H only |
| | |

Color Bin Limits

| Color Bir | 1 Limits | |
|------------------|----------|----------|
| Blue | Min (nm) | Max (nm) |
| A | 460.0 | 465.0 |
| В | 465.0 | 470.0 |
| С | 470.0 | 475.0 |
| D | 475.0 | 480.0 |
| Green | Min (nm) | Max (nm) |
| A | 515.0 | 520.0 |
| В | 520.0 | 525.0 |
| С | 525.0 | 530.0 |
| D | 530.0 | 535.0 |
| Amber/ Yellow | Min (nm) | Max (nm) |
| A | 582.0 | 584.5 |
| В | 584.5 | 587.0 |
| С | 587.0 | 589.5 |
| D | 589.5 | 592.0 |
| E | 592.0 | 594.5 |
| F | 594.5 | 597.0 |
| Red | Min (nm) | Max (nm) |

Tolerance of each bin limit = ± 1 nm

Packaging Option (X_8X_9)

Full Distribution

| X_8X_9 | |
|----------|--|
| J1 | 20mA test current, Top Mount, 7 inch Reel |
| J2 | 10mA test current, Top Mount, 7 inch Reel |

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